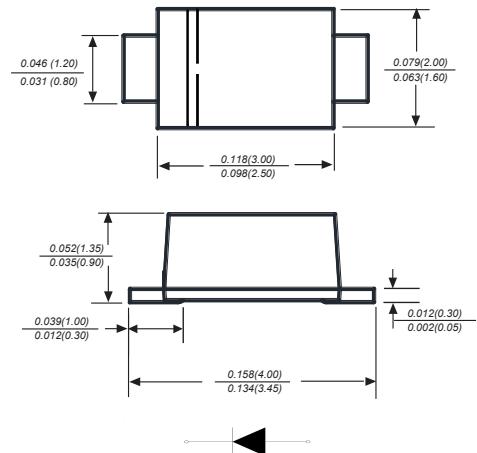


## SURFACE MOUNT GENERAL PURPOSE SILICON RECTIFIER

### Features

- ◆ Glass passivated device
- ◆ Ideal for surface mounted applications
- ◆ Low reverse leakage
- ◆ Metallurgically bonded construction
- ◆ High temperature soldering guaranteed:
- ◆ 250°C/10 seconds, 0.375"(9.5mm) lead length, 5 lbs. (2.3kg) tension

**SOD-123FL**



Dimensions in inches and (millimeters)

### Mechanical Data

Case<sup>1</sup>: JEDEC UOD-123FL molded plastic body

Terminals<sup>2</sup>: Solderable per MIL-STD-750, Method 2026A

Polarity<sup>3</sup>: Polarity symbol marking on body

Mounting Position<sup>4</sup>: Any

Weight : 0.0053 ounce, 0.015grams

### Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	S2AW	S2BW	S2DW	S2GW	S2JW	S2KW	S2MW	UNITS
Marking Code		2A1	2A2	2A3	2A4	2A5	2A6	2A7	
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at TL(see fig.1)	I <sub>(AV)</sub>	2.0						A	
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I <sub>FSM</sub>	50						A	
Maximum instantaneous forward voltage at 2.0A	V <sub>F</sub>	1.1						V	
Maximum DC reverse current TA=25°C at rated DC blocking voltage TA=125°C	I <sub>R</sub>	5 50						uA	
Typical junction capacitance (NOTE 1)	C <sub>J</sub>	25						pF	
Typical thermal resistance (NOTE 2)	R <sub>θJA</sub> R <sub>θJC</sub>	75 22						°C/W	
Operating junction temperature range	T <sub>J</sub>	-55 to +150						°C	
Storage temperature range	T <sub>STG</sub>	-55 to +150						°C	

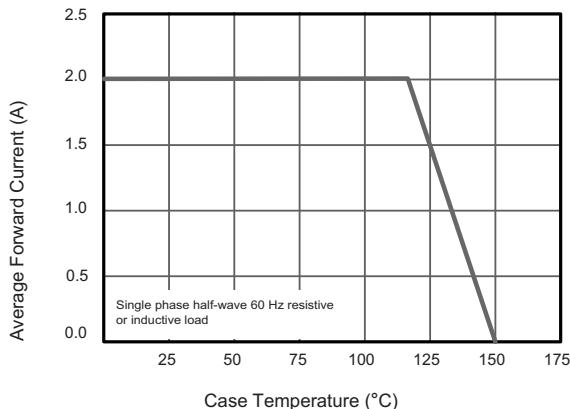
**Note:** 1.Averaged over any 20ms period.

2.Measured at 1MHz and applied reverse voltage of 4.0V D.C.

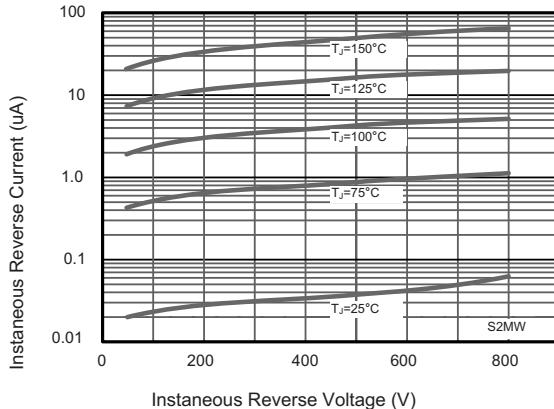
3.Thermal resistance from junction to ambient at 0.375" (9.5mm) lead length,P.C.B. mounted

## Typical Characteristics

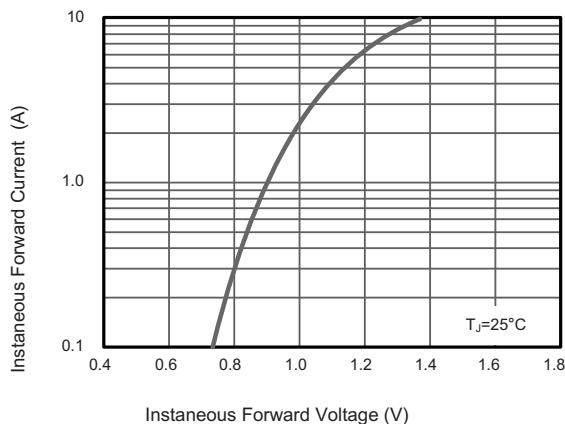
**Fig.1 Forward Current Derating Curve**



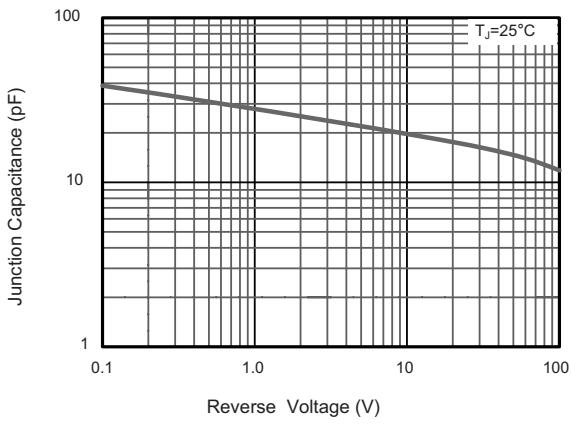
**Fig.2 Typical Instantaneous Reverse Characteristics**



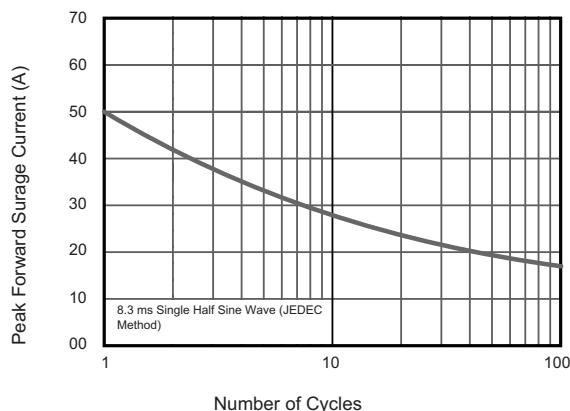
**Fig.3 Typical Forward Characteristic**



**Fig.4 Typical Junction Capacitance**

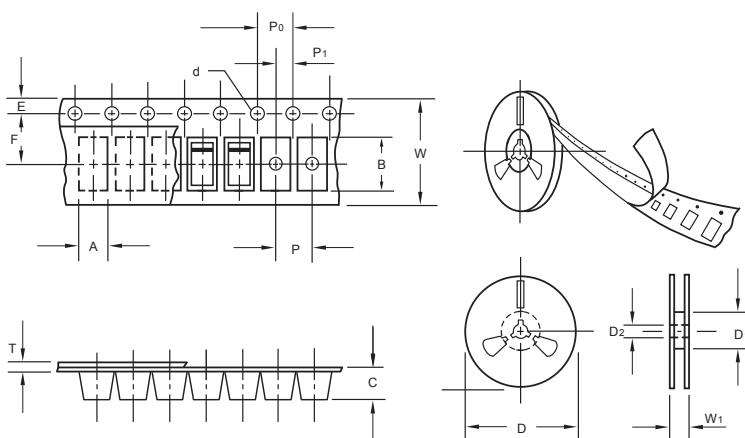


**Fig.5 Maximum Non-Repetitive Peak Forward Surge Current**



The curve above is for reference only.

## Packing information



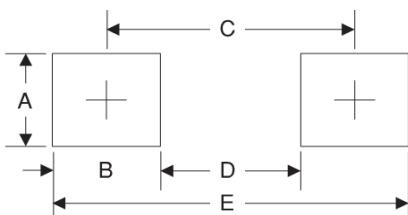
unit:mm			
Item	Symbol	Tolerance	SOD-123FL
Carrier width	A	0.1	2.1
Carrier length	B	0.1	4.0
Carrier depth	C	0.1	1.60
Sprocket hole	d	0.05	1.55
7" Reel outside diameter	D	2.0	178.00
7" Reel inner diameter	D <sub>1</sub>	min	50.0
Feed hole diameter	D <sub>2</sub>	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	3.50
Punch hole pitch	P	0.1	4.00
Sprocket hole pitch	P <sub>0</sub>	0.1	4.00
Embossment center	P <sub>1</sub>	0.1	2.00
Overall tape thickness	T	0.1	0.25
Tape width	W	0.3	8.15
Reel width	W <sub>1</sub>	1.0	10.5

Note: Devices are packed in accordance with EIA standard RS-481-A and specifications listed above.

## Reel packing

PACKAGE	REEL SIZE	REEL (pcs)	COMPONENT SPACING (m/m)	BOX (pcs)	INNER BOX (m/m)	REEL DIA, (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
SOD-123FL	7"	3,000	4.0	45,000	210*208*203	178	430*430*235	180,000	9.0

## Suggested Pad Layout



Symbol	Unit (mm)	Unit (inch)
A	1.2	0.047
B	1.2	0.047
C	3.2	0.126
D	2	0.079
E	4.4	0.173